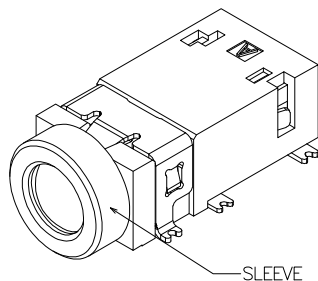
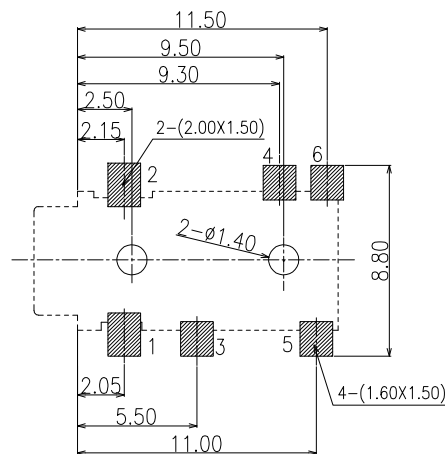
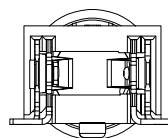
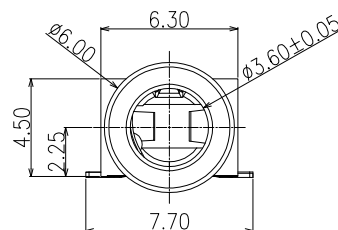
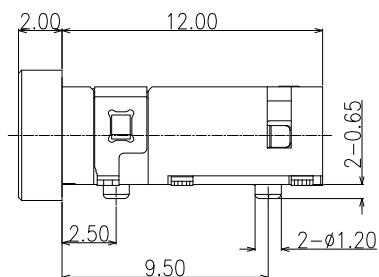
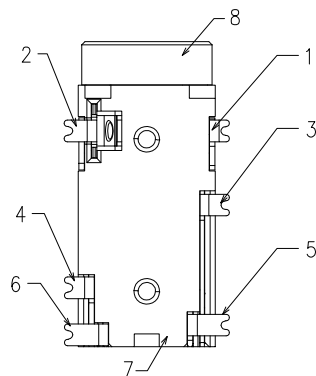


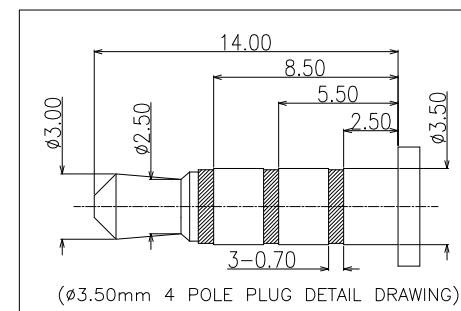
RoHS Compliant



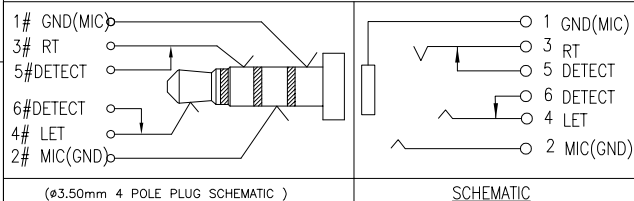
3D VIEW



P.C.B LAYOUT
TOP VIEW



1. CONTACT CURRENT RATING: 1A.
2. CONTACT RESISTANCE: 30 mΩ MAX.;
3. INSULATION RESISTANCE: 100MΩ MIN.;
4. DIELECTRIC WITHSTANDING: 500V AC MIN.;
5. DURABILITY: 5,000 CYCLES MIN.;
6. CONNECTOR MATING FORCES: 30N MAX.;
7. CONNECTOR UNMATING FORCES: 3N MIN.;



8	SLEEVE	COPPER ALLOY;THE BOTTOM OF THE NICKEL; THE WHOLE GOLD PLATING.	1	
7	HOUSING	HIGHT TEMPERATURE PLASTIC COLOR BLACK	1	
6	TERMINAL 6#	COPPER ALLOY; THE BOTTOM OF THE NICKEL;GOLD PLATING ON SOLDER AREA ;	1	T=0.25mm
5	TERMINAL 5#		1	T=0.25mm
4	TERMINAL 4#	COPPER ALLOY; NICKEL UNDER PLATING OVERALL;GOLD PLATING ON SOLDER AREA ;GOLD PLATING ON CONTACT AREA	1	T=0.25mm
3	TERMINAL 3#		1	T=0.25mm
2	TERMINAL 2#		1	T=0.25mm
1	TERMINAL 1#	COPPER ALLOY; THE BOTTOM OF THE NICKEL; THE WHOLE GOLD PLATING.	1	T=0.25mm
NO.	DESCRIPTION	MATERIAL	QTY	NOET

UNLESS OTHERWISE,
GENERAL TOLERANCE:
X.xxx ±0.10
X.xx ±0.20
X.x ±0.30
X. ±0.50
ANGULAR:
X.xx ±1°
X.x ±3°
X. ±5°

XB 东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

TITLE: Ø3.5mm PHONE JACK H=4.5 mm SMT TYPE CONNECTOR	P/N: XB-J3520F06G1001			
	MODEL: _____			
	DRAW NO.: _____			
THIRD ANGLE PROJECTION 	UNIT:	SCALE:	SIZE:	SHEET:
	mm	1:1	A4	1/1

DESIGN		ZB	2018.10.25		
CHECK		ZB	2018.10.25		
APPROVAL		YCW	2018.10.25		
N/A	A	NEW DRAWING		2018.10.25	ZB
ECN NO.	REV.	DESCRIPTION		DATE	CHANGE